

# PMBT2222; PMBT2222A

# **NPN** switching transistors

Rev. 6 — 12 November 2010

Product data sheet

### 1. Product profile

#### 1.1 General description

NPN switching transistors in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package.

Table 1. Product overview

Type number	Package		PNP complement
	NXP	JEDEC	
PMBT2222	SOT23	TO-236AB	PMBT2907
PMBT2222A			PMBT2907A

#### 1.2 Features and benefits

- High current (max. 600 mA)
- Low voltage (max. 40 V)

### 1.3 Applications

Switching and linear amplification

#### 1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CEO}$	collector-emitter voltage	open base				
	PMBT2222		-	-	30	V
	PMBT2222A		-	-	40	V
I <sub>C</sub>	collector current		-	-	600	mA
h <sub>FE</sub>	DC current gain	$V_{CE} = 10 \text{ V};$ $I_{C} = 150 \text{ mA}$	11 100	-	300	
	PMBT2222	$V_{CE} = 10 \text{ V};$ $I_{C} = 500 \text{ mA}$	<u>[1]</u> 30	-	-	
	PMBT2222A	$V_{CE} = 10 \text{ V};$ $I_{C} = 500 \text{ mA}$	<u>[1]</u> 40	-	-	

<sup>[1]</sup> Pulse test:  $t_p \leq 300~\mu s;~\delta \leq 0.02.$ 



# 2. Pinning information

Table 3. Pinning

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Pin	Description	Simplified outline	Graphic symbol
1	base		
2	emitter	3	3 
3	collector	1 2	1—
			2 sym021

# 3. Ordering information

Table 4. Ordering information

Type number	Package		
	Name	Description	Version
PMBT2222	-	plastic surface-mounted package; 3 leads	SOT23
PMBT2222A			

# 4. Marking

Table 5. Marking codes

Type number	Marking code[1]
PMBT2222	*1B
PMBT2222A	*1P

[1] \* = placeholder for manufacturing site code

### 5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

	_ ,				
Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CBO}$	collector-base voltage	open emitter			
	PMBT2222		-	60	V
	PMBT2222A		-	75	V
$V_{CEO}$	collector-emitter voltage	open base			
	PMBT2222		-	30	V
	PMBT2222A		-	40	V
$V_{EBO}$	emitter-base voltage	open collector			
	PMBT2222		-	5	V
	PMBT2222A		-	6	V
I <sub>C</sub>	collector current		-	600	mA
I <sub>CM</sub>	peak collector current		-	800	mA
I <sub>BM</sub>	peak base current		-	200	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25  ^{\circ}C$	<u>[1]</u> -	250	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

#### 6. Thermal characteristics

Table 7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1] -	-	500	K/W

<sup>[1]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

### 7. Characteristics

Table 8. Characteristics

 $T_i = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>CBO</sub>	collector-base cut-off current						
	PMBT2222	$V_{CB} = 50 \text{ V}; I_{E} = 0 \text{ A}$		-	-	10	nA
		$V_{CB} = 50 \text{ V}; I_{E} = 0 \text{ A};$ $T_{j} = 125 ^{\circ}\text{C}$		-	-	10	μΑ
	collector-base cut-off current						
	PMBT2222A	$V_{CB} = 60 \text{ V}; I_E = 0 \text{ A}$		-	-	10	nA
		$V_{CB} = 60 \text{ V}; I_E = 0 \text{ A};$ $T_j = 125 \text{ °C}$		-	-	10	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$		-	-	10	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = 10 \text{ V};$ $I_{C} = 0.1 \text{ mA}$		35			
		$V_{CE} = 10 \text{ V};$ $I_C = 1 \text{ mA}$		50	-	-	
		$V_{CE} = 10 \text{ V};$ $I_C = 10 \text{ mA}$		75	-	-	
		$V_{CE} = 10 \text{ V};$ $I_{C} = 10 \text{ mA};$ $T_{amb} = -55 \text{ °C}$		35	-	-	
		$V_{CE} = 10 \text{ V};$ $I_{C} = 150 \text{ mA}$	<u>[1]</u>	100	-	300	
		$V_{CE} = 1 \text{ V};$ $I_C = 150 \text{ mA}$	<u>[1]</u>	50	-	-	
	DC current gain	$V_{CE} = 10 \text{ V};$ $I_{C} = 500 \text{ mA}$	[1]				
	PMBT2222			30	-	-	
	PMBT2222A			40	-	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_C = 150 \text{ mA};$ $I_B = 15 \text{ mA}$	<u>[1]</u>				
	PMBT2222			-	-	400	mV
	PMBT2222A			-	-	300	mV
	collector-emitter saturation voltage	$I_C = 500 \text{ mA};$ $I_B = 50 \text{ mA}$	[1]				
	PMBT2222			-	-	1.6	V
	PMBT2222A			-	-	1	V

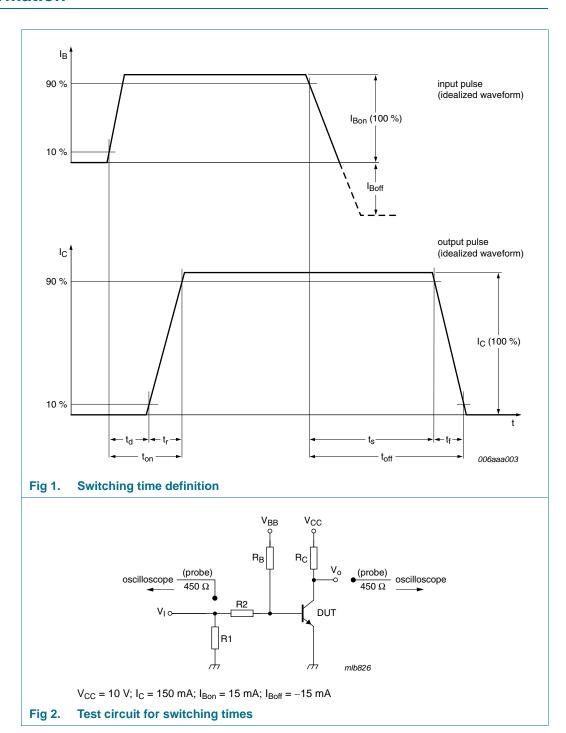
 Table 8.
 Characteristics ...continued

 $T_i = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{BEsat}$	base-emitter saturation voltage	$I_C = 150 \text{ mA};$ $I_B = 15 \text{ mA}$	<u>[1]</u>			
	PMBT2222		-	-	1.3	V
	PMBT2222A		0.6	-	1.2	V
	base-emitter saturation voltage	$I_C = 500 \text{ mA};$ $I_B = 50 \text{ mA}$	<u>[1]</u>			
	PMBT2222		-	-	2.6	V
	PMBT2222A		-	-	2	V
C <sub>c</sub>	collector capacitance	$V_{CB} = 10 \text{ V};$ $I_E = i_e = 0 \text{ A};$ $f = 1 \text{ MHz}$	-	-	8	pF
C <sub>e</sub>	emitter capacitance	$V_{EB} = 500 \text{ mV};$ $I_C = i_C = 0 \text{ A};$ f = 1  MHz				
	PMBT2222		-	-	30	pF
	PMBT2222A		-	-	25	pF
f <sub>T</sub>	transition frequency	$V_{CE} = 20 \text{ V};$ $I_{C} = 20 \text{ mA};$ $f = 100 \text{ MHz}$				
	PMBT2222		250	-	-	MHz
	PMBT2222A		300	-	-	MHz
NF	noise figure	$V_{CE} = 5 \text{ V};$ $I_{C} = 100  \mu\text{A};$ $R_{S} = 1  k\Omega;$ $f = 1  k\text{Hz}$	-	-	4	dB
t <sub>d</sub>	delay time	$V_{CC} = 10 \text{ V};$	-	-	15	ns
t <sub>r</sub>	rise time	<sup>−</sup> I <sub>C</sub> = 150 mA; − I <sub>Bon</sub> = 15 mA;	-	-	20	ns
t <sub>on</sub>	turn-on time	$I_{Boff} = -15 \text{ mA}$	-	-	35	ns
ts	storage time		-	-	200	ns
t <sub>f</sub>	fall time		-	-	60	ns
t <sub>off</sub>	turn-off time		-	-	250	ns

<sup>[1]</sup> Pulse test:  $t_p \leq 300~\mu s;~\delta \leq 0.02.$ 

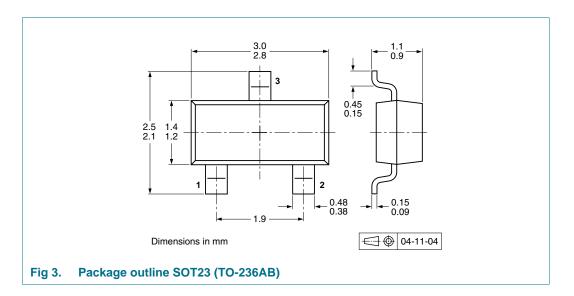
### 8. Test information



### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

### 9. Package outline



# 10. Packing information

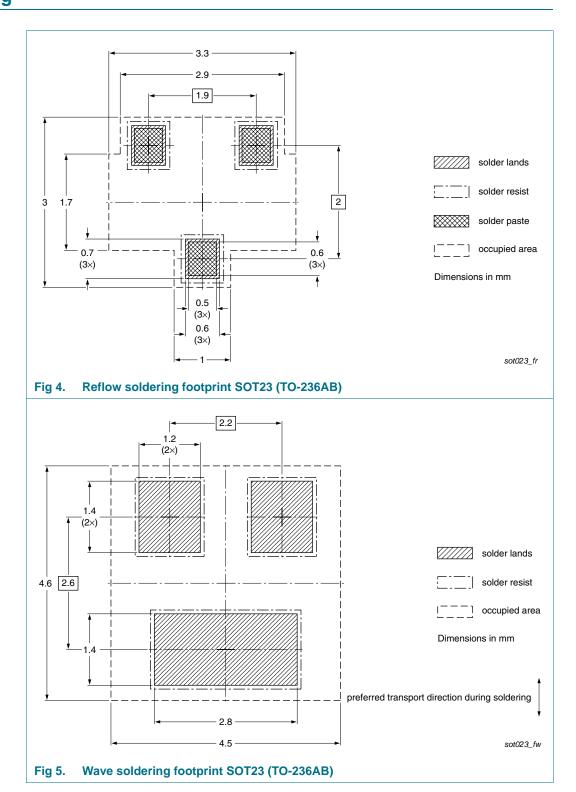
Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantity	
			3000	10000
PMBT2222	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235
PMBT2222A				

<sup>[1]</sup> For further information and the availability of packing methods, see Section 14.

# 11. Soldering



# 12. Revision history

#### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
PMBT2222_PMBT2222A v.6	20101112	Product data sheet	-	PMBT2222_2222A_5	
Modifications:	<ul> <li>Section 4 "M</li> </ul>	Section 4 "Marking": updated			
	• Figure 1 "Sw	Figure 1 "Switching time definition": added			
	<ul> <li>Section 8 "Te</li> </ul>	Section 8 "Test information": updated			
	<ul> <li>Section 10 "I</li> </ul>	Section 10 "Packing information": added			
	<ul> <li>Section 11 "S</li> </ul>	Soldering": added			
	<ul> <li>Section 13 "I</li> </ul>	Legal information": updated			
PMBT2222_2222A_5	20040122	Product specification	-	PMBT2222_2222A_4	
PMBT2222_2222A_4	19990427	Product specification	-	PMBT2222_3	
PMBT2222_3	19970909	Product specification	-	-	

### 13. Legal information

#### 13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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# PMBT2222; PMBT2222A

**NPN** switching transistors

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